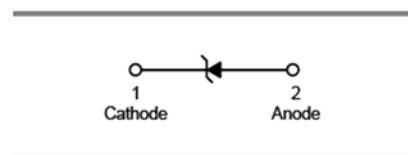


Surface Mount Zener Diode



SOD-123

Features:

- Planar Die Construction
- 500mW Power Dissipation
- General Purpose, Medium Current
- Ideally Suited For Automated Assembly Processes

Applications:

- Zener diode
- Ultra-small surface mount package

Maximum Rating @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Forward voltage @ I _F = 10mA	V _F	0.9	V
Power dissipation	P _D	500	mW
Thermal resistance, junction to ambient air	R _{θjA}	350	°C/W
Junction temperature	T _j	150	°C
Storage temperature range	T _{stg}	-65 to +150	°C

Note : Device mounted on ceramic PCB; 7.6mm × 9.4mm × 0.87mm with pad areas 25mm².
Tested with pulses, T_p ≤ 1ms.

Electrical Characteristics @ TA = 25°C unless otherwise specified

Type Number	Type Code	Zener Voltage Range			Test Current	Maximum Zener Impedance		Maximum Reverse Leakage Current	
		V _Z @I _{ZT}				I _{ZT}	Z _{ZT} @I _{ZT}	Z _{ZK} @I _{ZK} = 0.25mA	I _R
		Nom(V)	Min(V)	Max(V)	mA	Ω		μA	V
MMSZ5232B	E2	5.6	5.32	5.88	20	11	1,600	5	3

Surface Mount Zener Diode



Typical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

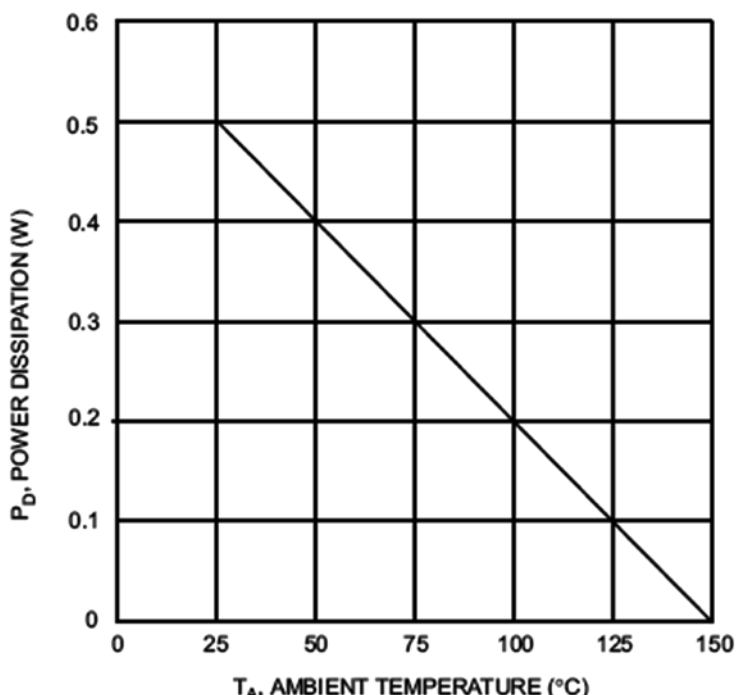
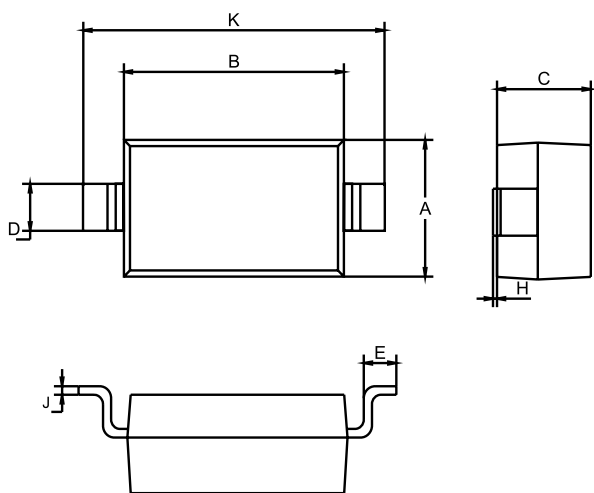


Fig. 1 Power Dissipation vs Ambient Temperature

Package Outline

Plastic surface mounted package



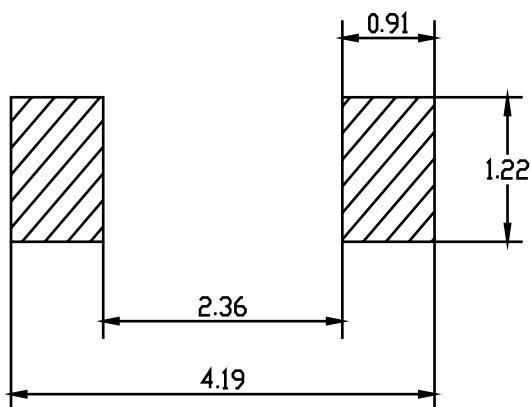
SOD-123		
Dim	Min	Max
A	1.4	1.8
B	2.55	2.85
C	1.15 Typical	
D	0.5	0.6
E	0.3	0.4
H	0.02	0.10
J	0.1 Typical	
K	3.55	3.85
All Dimensions in mm		



Surface Mount Zener Diode



Soldering Footprint



Dimensions : Millimetres

Package Information

Device	Package	Shipping
MMSZ5232B-7-F	SOD-123	3,000/Tape & Reel

Part Number Table

Description	Part Number
Surface Mount Zener Diode	MMSZ5232B-7-F

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